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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
Ching-Chung Ko	02/16/2009
Tung-Hsing Lee	02/16/2009

RECEIVING PARTY DATA

Name:	MEDIATEK INC.	
Street Address:	S: No. 1, Dusing Rd. 1st, Science-Based Industrial Park	
City:	Hsin-Chu	
State/Country: TAIWAN		

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14161570	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	MTKP0784USA1	
NAME OF SUBMITTER:	SHELLEY KUO	
Signature:	/SHELLEY KUO/	
Date:	01/22/2014	

Total Attachments: 2 source=1858727#page1.tif source=1858727#page2.tif

> PATENT REEL: 032023 FRAME: 0536

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

Nar	me:	Ching-Chung Ko	N	ationality: TWN				
Nar	me:	Tung-Hsing Lee	N	ationality: TWN				
Hereby sells, assigns and transfers to								
ASSIGN	EE(S)	:						
Na	me:	MEDIATEK INC.						
Ad	ldress:	ess: No. 1, Dusing Rd. 1st, Science-Based Industrial Park, Hsin-Chu 300, Taiwan, R.O.C.						
and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:								
"LATERAL BIPOLAR JUNCTION TRANSISTOR"								
Which is found in:								
(a)	+	U.S. patent application executed on even date						
(b)		U.S. patent application executed on						
(c)	c) U.S. application serial no							
(d)		patent no.	issued					

ASSIGNOR(S) (Inventors):

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this signing). (請發明人務必簽署上列日期:)

(Type name of inventor)

Signature of INVENTOR

Chang-Chang Ko

Ching-Chung Ko

Tung-Hsing Lee

Assignment, Page 2 of 2

F#NPO-P0002E-US1

RECORDED: 01/22/2014